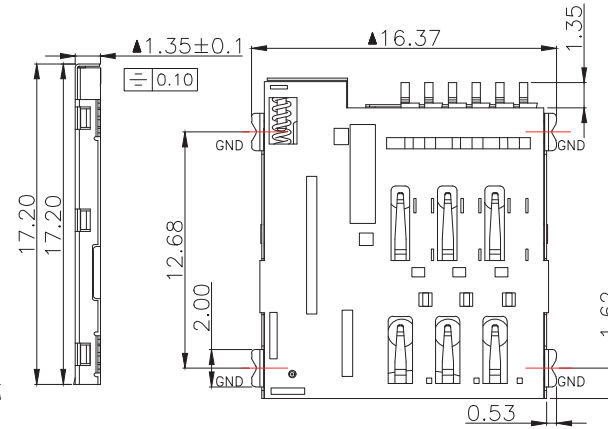
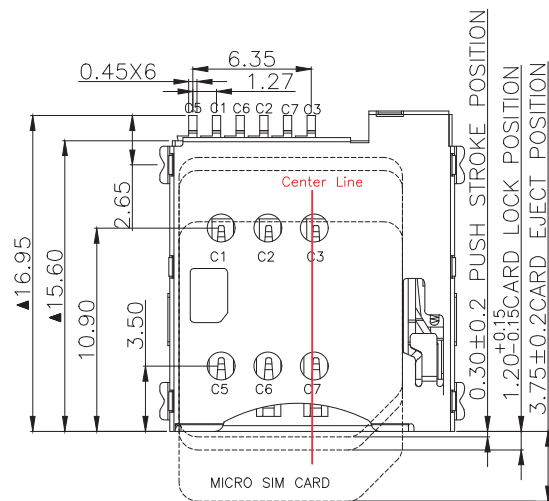




MATERIAL:

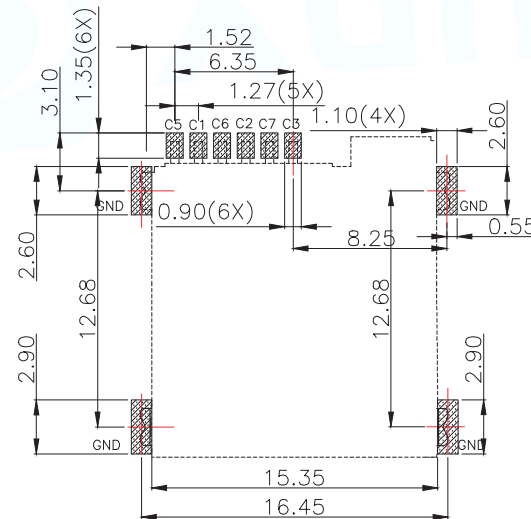
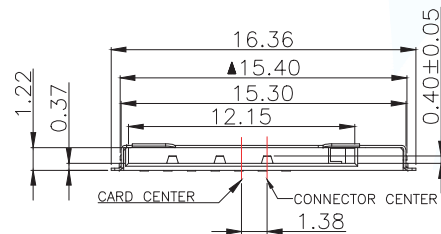
INSULATOR: HIGH TEMPERATURE THERMOPLASTIC,UL 94V-0
CONTACT: COPPER ALLOY
SHELL: SUS

PLATING:

CONTACT: PLATED 50U" NI OVER ALL CONTACT AU 1U
SHELL: PLATED 50U" NI OVERALL
PLATED 1U" AU SELECTIVE CONTACT AREA

ELECTRICAL:

CURRENT RATING: 0.5MA
VOLTAGE RATING: 5V AC/DC
AMBIENT TEMPERATURE RANGE: -40℃ ~ +85℃
STORAGE TEMPERATURE RANGE: -40℃ ~ +85℃
AMBIENT HUMIDITY RANGE: 95% R.H. MAX.
CONTACT RESISTANCE: 100M MAX.Ω
INSULATION RESISTANCE: 1000M MIN./500VDCΩ
REFLOW PEAK TEMP: 260℃
MATING CYCLES: 5000MIN INSERTIONS

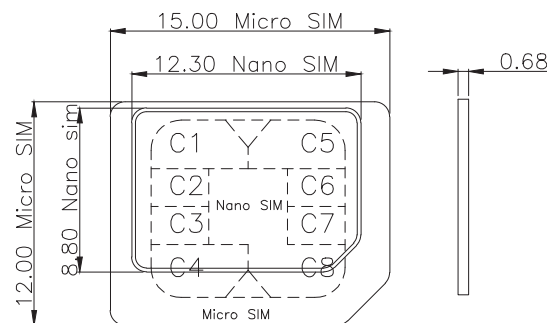
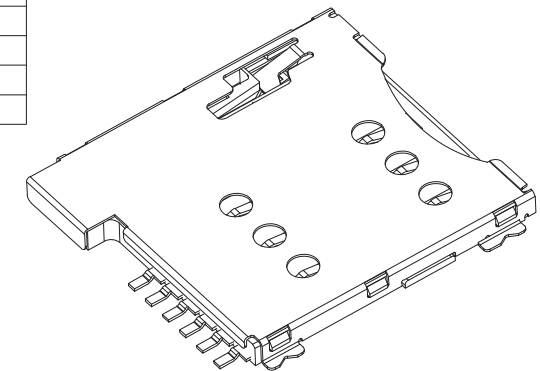


PAD AREA

KEEP OUT AREA

RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE ±0.05

MICRO SIM CARD	
Pin No.	NAME
C1	VCC OF SIM
C2	RST OF SIM
C3	CLK OF SIM
C5	GND OF SIM
C6	VPP OF SIM
C7	I/O OF SIM
C4/C8	N/A



MANUFACTURE DWG		 东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd	
UNLESS OTHERWISE SPECIFIED TOLERANCES			TITLE: MICRO SIM CARD PUSH 6PIN H1.35
			PAR SMC-202-6
DECIMALS:	ANGLES: ±1°		DWN
X.X: ±0.15			CHKD
X.XX: ±0.10			APVD
X.XXX: ±0.05			SCALE 1:1 UNIT: MM
CUSTOMER COPY		SIZE: A4	SHEET: 1F1 REV: A

A

B

C

D

E

F

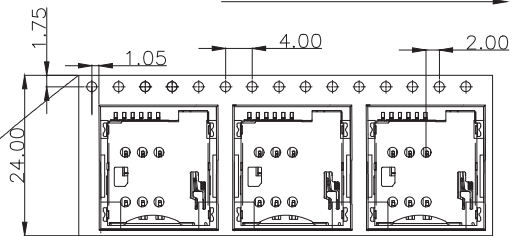
G

H

I

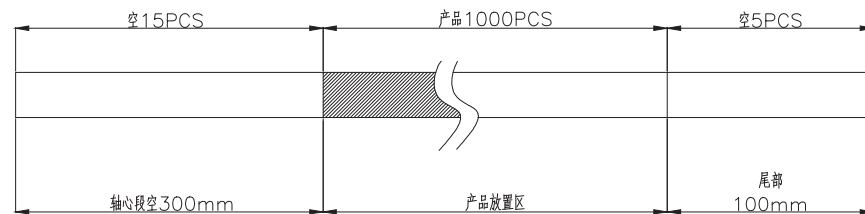
J

客户拉出方向



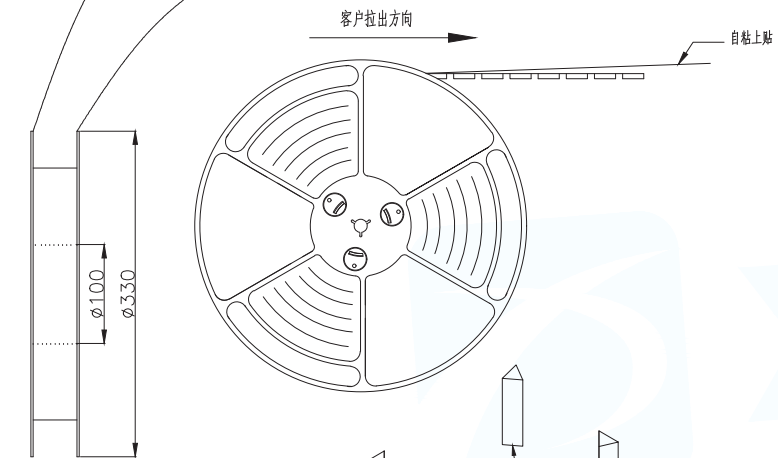
NOTES

- 1.每卷包装数量:1000PCS/每卷
- 2.卷带包装方式:



- 3.每箱包装数量:10000PCS/箱

- 4.纸箱350mm*350mm*440mm(内部尺寸),材质K=K



纸箱底部和顶部各垫一块珍珠棉

纸箱

护角

封箱胶带

外箱标签贴示位置

将10卷产品放入箱内

MANUFACTURE DWG		 东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd	
UNLESS OTHERWISE SPECIFIED TOLERANCES			TITLE:MICRO SIM CARD PUSH 6PIN H1.35 包装图
			PAR SMC-202-6
DECIMALS:	ANGLES:±1°		DWN
X.X:±0.15			CHKD
X.XX:±0.10			APVD
X.XXX:±0.05			SCALE 1:1 UNIT:MM
CUSTOMER COPY		SIZE:A4	SHEET:1F1 REV:A